

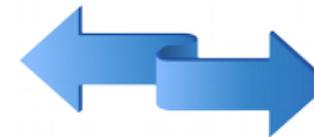
Reflow Vapor Phase Machine

For Mini Series and Prototyping Production

SV260



The **SV260** vapor phase machine is characterized by its **2-chamber design** and the **easy handling**. The machine is perfect for small volume production and offers **superior solder quality**. Especially she was designed for development and prototype production as well as for soldering BGAs and LGAs. Due to its **small footprint**, it's quickly ready for use.



- ✓ *Touchpanel*
- ✓ *Solder automatic*
- ✓ *Medium level check*
- ✓ *Obervation window to process chamber*
- ✓ *Energy management system*
- ✓ *Fully automatic solder cycle*
- ✓ *Integrated cooling fan*
- ✓ *SD card slot*



Overview

- Table-top unit with front loading
- 2-chamber design for low consumption
- Oxygen free soldering
- No overheating of components
- No  $\Delta T$ 's throughout the assembly

SPECIAL FEATURES

- Maintenance-free transport system (*patented*)
- Low medium consumption with 2-chamber design and medium recovery
- Program memory for up to 16 programs
- Easy profil recording option
- Exhaust connection



Options

- Adapter for double sided PCB's
- ReSy, reworksystem
- Stainless steel grid for the workpiece carrier
- Closed-loop-chiller
- TE-Option for external profile monitoring
- USB profiling system
- Movable under-desk

Reflow Vapor Phase Machine

For Mini Series and Prototyping Production

**SV260**

Technical Data	SV260
Length (over all)	770 mm
Depth	710 mm
Height	680 mm
Weight	110 kg
Max. board size	300 x 260 x 70 mm
Medium agent filling	3 kg
Water connection	1/2" / 2,5-5 bar / 1 l/min
Max. heating capacity	2,1 kW
Ø power consumption	0,9 kW/h
Power supply	230 VAC, 50/60 Hz, 2,2 KW
Main fuse	16 A, Typ "gL" or "C"

- Technical changes reserved -